

PRODUCT FEATURES

- IGBT CHIP(Trench+Field Stop technology)
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses



APPLICATIONS

- High frequency switching application
- Medical applications
- Motion/servo control
- UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	630	A
		$T_C=90^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	450	
I_{CM}	Repetitive Peak Collector Current	$tp=1\text{ms}$	900	
P_{tot}	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	2142	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current		400	A
I_{FRM}	Repetitive Peak Forward Current	$tp=1\text{ms}$	800	
I^2t		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	39.2	KA^2s

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MMG450D120B6TC

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=18\text{mA}$	5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector - Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.85	2.25	
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.15		
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		2.2		
I_{CES}	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			0.5	mA
		$V_{CE}=1280\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-400		400	nA
R_{Gint}	Integrated Gate Resistor			1.4		Ω
Q_G	Gate Charge	$V_{CE}=600\text{V}, I_C=450\text{A}, V_{GE}=15\text{V}$		2.25		μC
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		31.5		nF
C_{res}	Reverse Transfer Capacitance				1.5	
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=450\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$	100		ns
			$T_J=125^\circ\text{C}$	120		ns
			$T_J=150^\circ\text{C}$	130		ns
t_r	Rise Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$	78		ns
			$T_J=125^\circ\text{C}$	86		ns
			$T_J=150^\circ\text{C}$	86		ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=600\text{V}, I_C=450\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$	550		ns
			$T_J=125^\circ\text{C}$	590		ns
			$T_J=150^\circ\text{C}$	610		ns
t_f	Fall Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$	120		ns
			$T_J=125^\circ\text{C}$	200		ns
			$T_J=150^\circ\text{C}$	220		ns
E_{on}	Turn on Energy	$V_{CC}=600\text{V}, I_C=450\text{A}$ $R_G=2.0\Omega,$	$T_J=125^\circ\text{C}$	39		mJ
			$T_J=150^\circ\text{C}$	42		mJ
E_{off}	Turn off Energy	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=125^\circ\text{C}$	52		mJ
			$T_J=150^\circ\text{C}$	56		mJ
I_{SC}	Short Circuit Current	$tpsc \leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=125^\circ\text{C}, V_{CC}=800\text{V}$		1700		A
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.07	K/W

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=400\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$	1.4	1.75	2.3	V
		$I_F=400\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.5		
		$I_F=400\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.45		
t_{rr}	Reverse Recovery Time	$I_F=450\text{A}, V_R=600\text{V}$ $di_F/dt=-5300\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		530		ns
I_{RRM}	Max. Reverse Recovery Current			485		A
Q_{RR}	Reverse Recovery Charge			133		μC
E_{rec}	Reverse Recovery Energy			59.5		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.12	K/W

MMG450D120B6TC

MODULE CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit	
T_{Jmax}	Max. Junction Temperature	175	$^\circ\text{C}$	
T_{Jop}	Operating Temperature	-40~150		
T_{stg}	Storage Temperature	-40~125		
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 225	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M6)	2.5~5	Nm
Weight			300	g

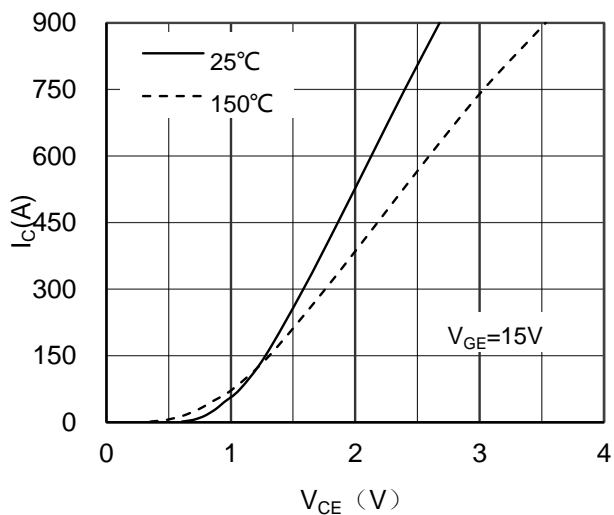


Figure 1. Typical Output Characteristics IGBT-inverter

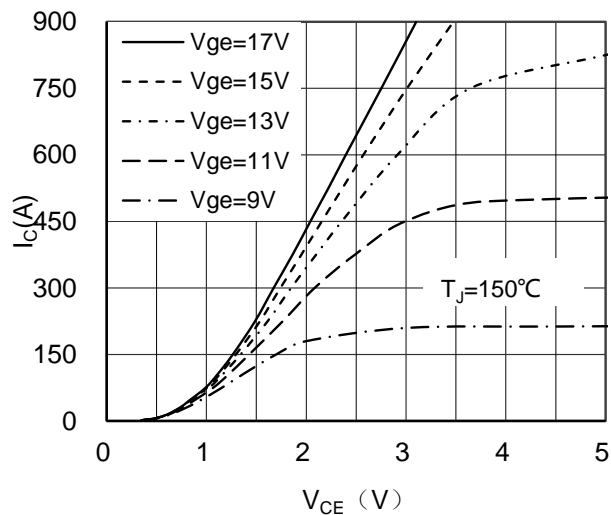


Figure 2. Typical Output Characteristics IGBT-inverter

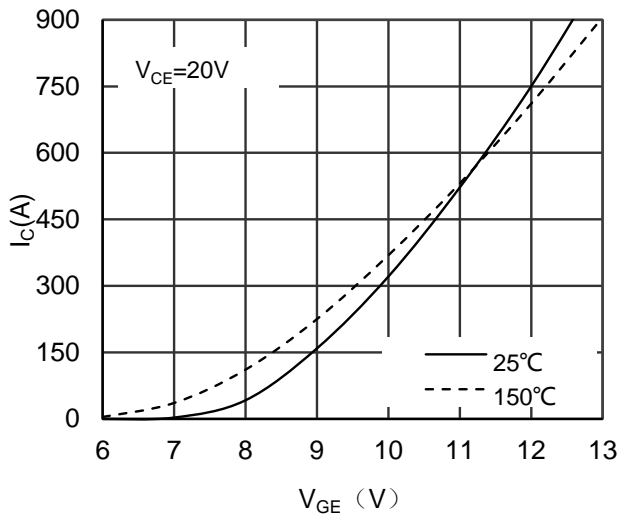


Figure 3. Typical Transfer characteristics IGBT-inverter

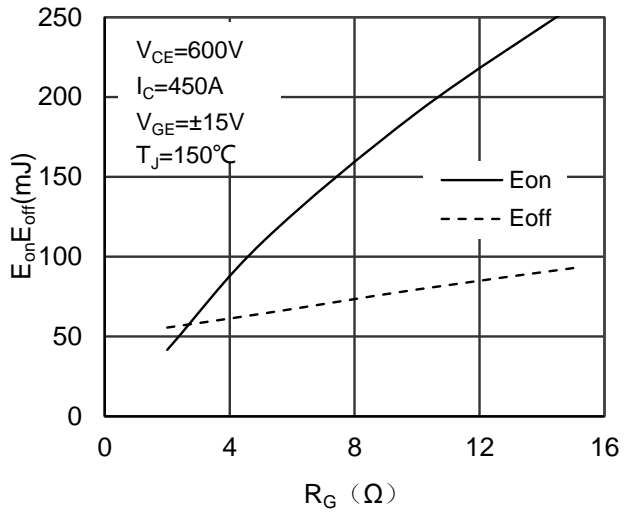


Figure 4. Switching Energy vs Gate Resistor IGBT-

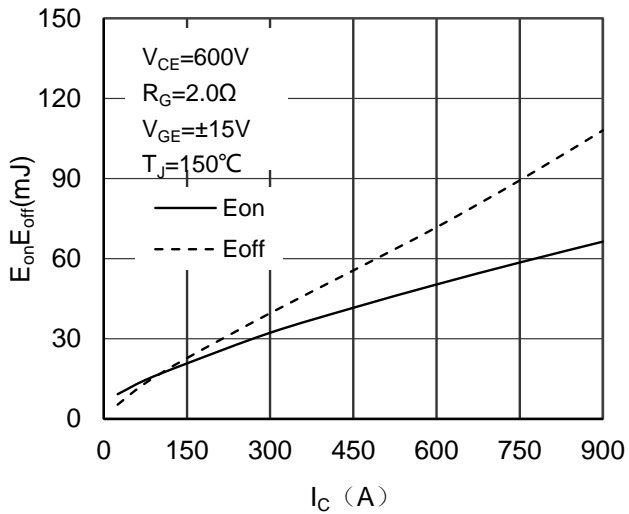


Figure 5. Switching Energy vs Collector Current IGBT-inverter

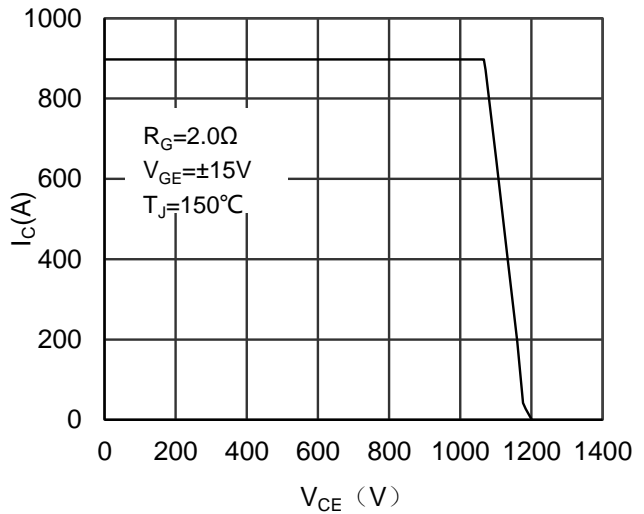


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

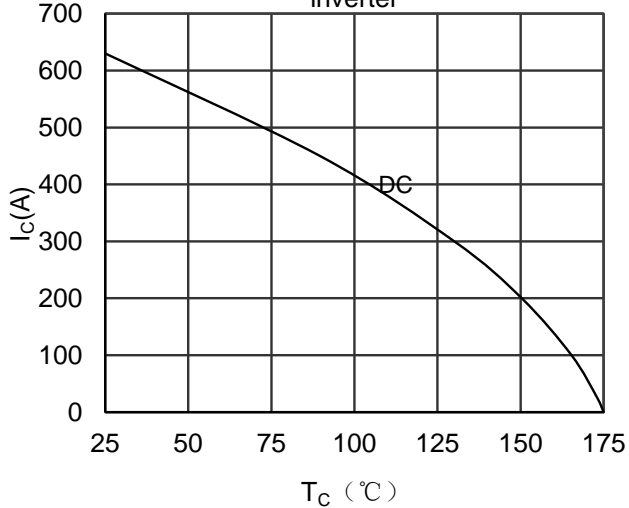


Figure 7. Collector Current vs Case temperature IGBT-inverter

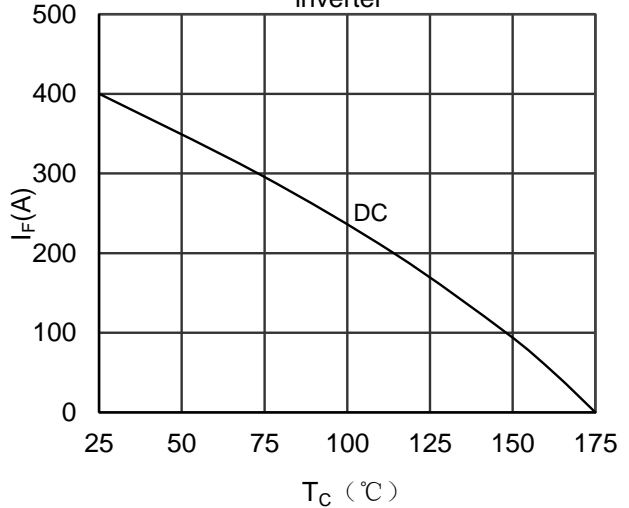


Figure 8. Forward current vs Case temperature Diode-inverter

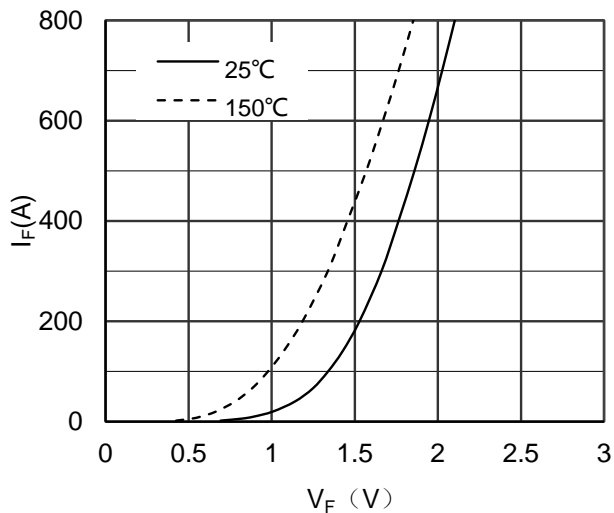


Figure 9. Diode Forward Characteristics Diode -inverter

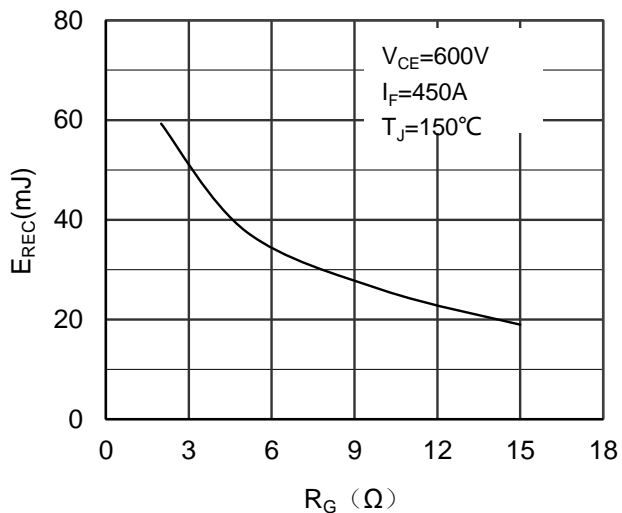


Figure 10. Switching Energy vs Gate Resistor Diode - inverter

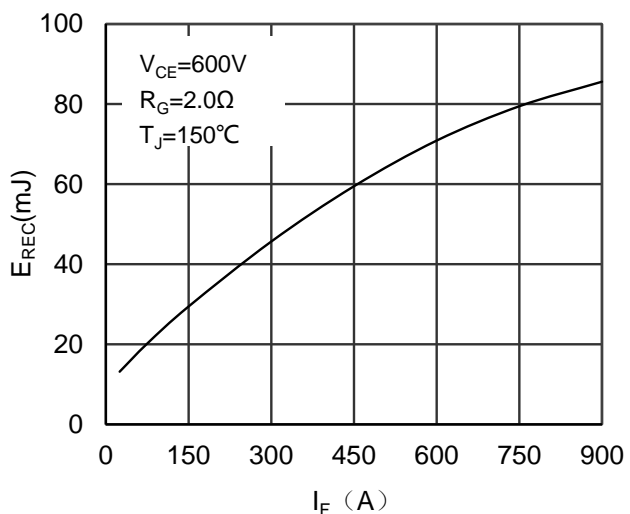


Figure 11. Switching Energy vs Forward Current Diode-

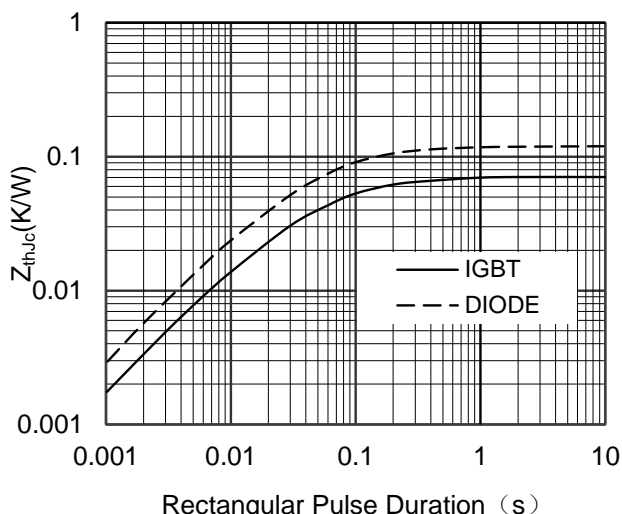
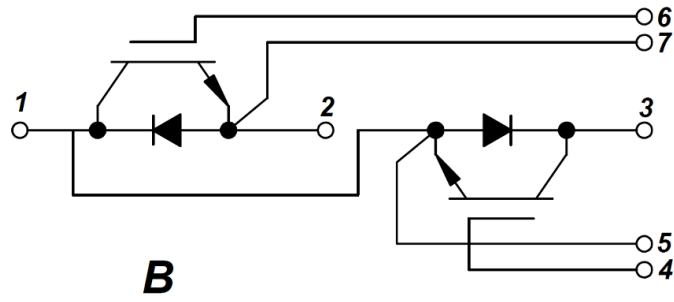
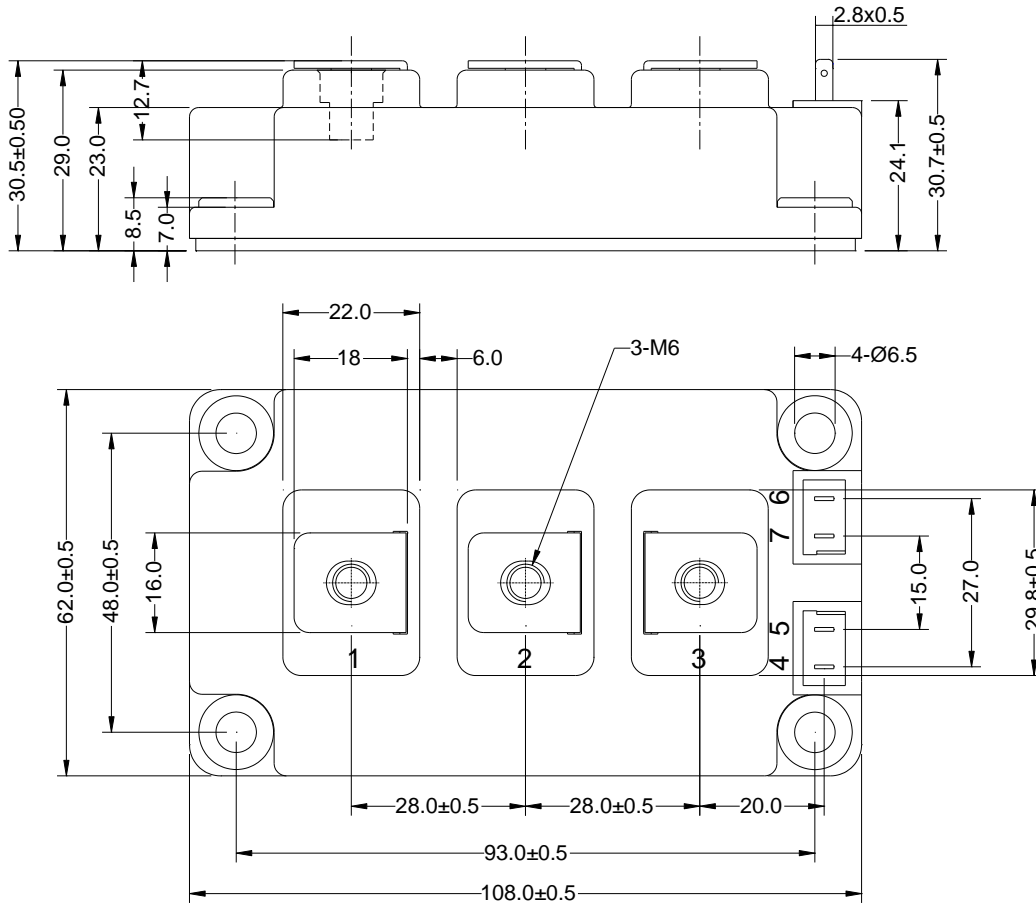


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter



B

Figure 13. Circuit Diagram



Dimensions in (mm)
Figure 14. Package Outline